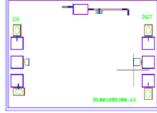
AMT1207B 7 – 13GHz Low Noise Amplifier Chip



Key Features :

- Frequency range : 7 13GHz
- Typical gain : 25dB
- Input/output standing wave : 2/1.7
- Noise figure : 1.2dB
- P-1 : 11dBm @ +4.1V/30mA
- Chip dimensions : 1.625mm x 1.15mm x 0.1mm
- Applications : wireless communication, transceiver module, radio telecommunication etc.

Description:

AMT1207B chip is a Gallium Arsenide (GaAs) high performance Low Noise Amplifier, it covers 7 – 13GHz frequency range. It uses +4.1V single voltage operation, noise figure is 1.2dB, and 25dB typical gain. This chip is designed with ground through metal vias on the back technology.

Absolute Maximum Ratings (Ta = 25°C)

Symbol	Parameter	Value	Remark
Vd	Drain Voltage	+7V	
Pin	Input Signal Power	17dBm	
Tch	Operating Temperature	150°C	
Tm	Sintering Temperature	310°C	30s, N ₂ protection
Tstg	Storage Temperature	-65 ~ +150°C	

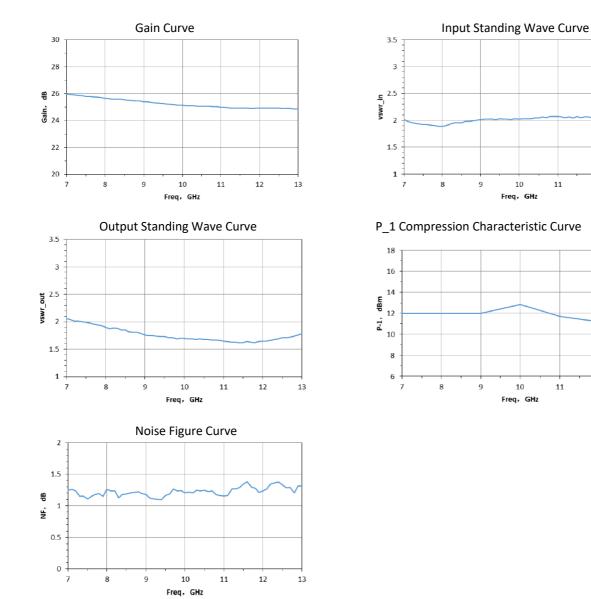
[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

Electrical Characteristics (Ta = 25°C)

Symbol	Parameter	Test Conditions Value		Unit		
			Min	Typical	Max	
G	Gain		-	25	-	dB
NF	Noise Figure		-	1.2	1.4	dB
Id	Static Current	Vd = +4.1V	-	30	-	mA
VSWR_in	Input Standing Wave	F : 7 ~ 13GHz	-	2	2.3	-
VSWR_out	Output Standing Wave		-	1.7	2.2	-
P-1	Output Power at 1dB point		9	11	-	dBm

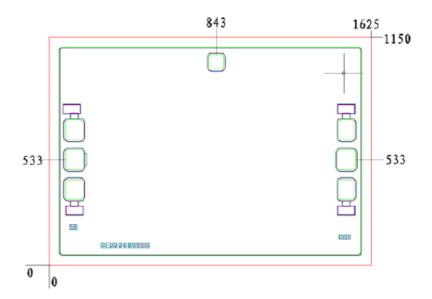
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Typical Performance

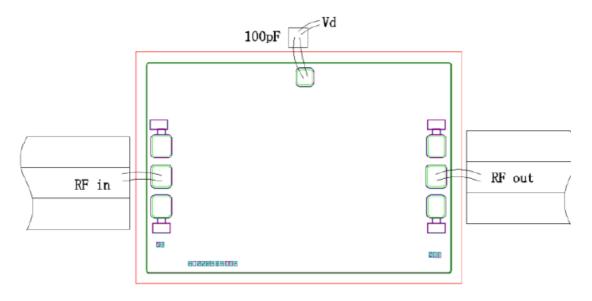


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Chip Dimensions (Unit : µm)



Chip Layout Diagram



Pad Definition

Symbol	Function	Dimension	Equivalent Circuit
RF_in	RF signal input port, connecting to external 50 Ω system. no need to add DC blocking capacitor.	100*100µm²	RF₋in ↔
RF_out	RF signal output port, connecting to external 50 Ω system, no need to add DC blocking capacitor.	100*100µm²	-⊢ RF_out
Vd	Amplifier bias, need to connect external 100pF capacitor.	100*100μm²	

Please see Appendix A for details.

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